506481118 02/02/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6527894

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIROSHI TSUJI	01/21/2021

RECEIVING PARTY DATA

Name:	SHIMADZU CORPORATION
Street Address:	1, NISHINOKYO-KUWABARACHO, NAKAGYO-KU, KYOTO-SHI,
City:	куото
State/Country:	JAPAN
Postal Code:	604-8511

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17263887

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 107235-US-1329-PCT

NAME OF SUBMITTER: BELINDA LEE

SIGNATURE: /Belinda Lee/

DATE SIGNED: 02/02/2021

Total Attachments: 2

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PATENT 506481118 REEL: 055105 FRAME: 0868

ASSIGNMENT

WHEREAS,

1. Hiroshi TSUJI

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: MATERIAL TESTING MACHINE

[x] Filed: Serial No. :

[] Executed concurrently with the execution of this instrument

WHEREAS, SHIMADZU CORPORATION

of 1, Nishinokyo-Kuwabara-cho, Nakagyo-ku, Kyoto-shi, Kyoto 604-8511 Japan

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Hirself Tan, 2, 202

Sole or First Joint Inventor: Hiroshi TSUJI